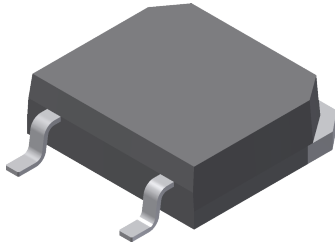


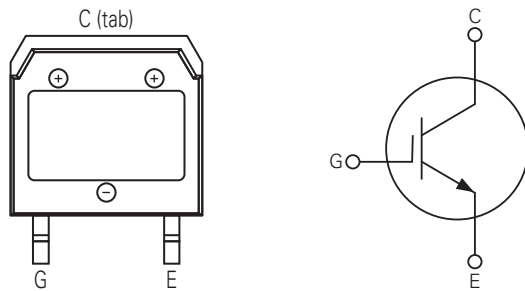
# IXYT120N65A5HV

## 650 V, 120 A Gen5 XPT™ IGBT

Extreme Light Punch Through IGBT for up to 5 kHz Switching



### Pinout Diagram (TO-268HV)



**G:** Gate; **C:** Collector; **E:** Emitter; **Tab:** Collector

### Description:

Developed using our proprietary XPT™ thin-wafer technology and state-of-the-art Trench IGBT process, these devices feature reduced thermal resistance, low conduction losses, and low gate driver requirements.

### Features & Benefits:

- Optimized for Low Conduction Losses
- High Surge Current Capability
- Square RBSOA
- International Standard Package
- Low Gate Charge  $Q_G$
- Low Gate Drive Requirement

### Applications:

- Power Inverters
- UPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts
- Inrush Current Protection Circuits

### Product Summary

Characteristic	Value	Unit
$V_{CES}$	650	V
$I_{C110}$	120	A
$V_{CE(sat)}$	1.45	V
$t_{fi(typ)}$	200	ns

## Maximum Ratings

Symbol	Characteristic	Conditions	Value	Unit
$V_{CES}$	Collector-Emitter Voltage	$T_J = 25\text{ °C to }175\text{ °C}$	650	V
$V_{CGR}$	Collector-Gate Voltage	$T_J = 25\text{ °C to }175\text{ °C}, R_{GE} = 1\text{ M}\Omega$	650	V
$V_{GES}$	Gate-Emitter Voltage	Continuous	$\pm 20$	V
$V_{GEM}$	Transient Gate-Emitter Voltage	Transient	$\pm 30$	V
$I_{C25}$	Continuous Collector Current	$T_C = 25\text{ °C (Chip Capability)}$	290	A
$I_{LRMS}$	Terminal Current Limit	–	160	A
$I_{C110}$	Continuous Collector Current	$T_C = 110\text{ °C}$	120	A
$I_{CM}$	Pulsed Collector Current	$T_C = 25\text{ °C}, 1\text{ ms}$	790	A
SSOA (RBSOA)	Switching Safe Operating Area (Reverse Biased Safe Operating Area)	$V_{GE} = 15\text{ V}, T_{VJ} = 150\text{ °C}, R_G = 3\ \Omega,$ Clamped Inductive Load, $I_{CM} = V_{CE} \leq V_{CES}$	240	A
$P_C$	Collector Power Dissipation	$T_C = 25\text{ °C}$	830	W
$T_J$	Junction Temperature	–	–55 to 175	°C
$T_{JM}$	Maximum Junction Temperature	–	175	°C
$T_{stg}$	Storage Temperature	–	–55 to 175	°C
$T_{SOLD}$	Soldering Temperature	Plastic Body for 10 s	260	°C
W	Weight	–	4	g

## Thermal Characteristic

Symbol	Characteristic	Value			Unit
		Min.	Typ.	Max.	
$R_{th,JC}$	Thermal Resistance, Junction-to-Case	–	–	0.18	°C/W

## Electrical Characteristics – Static ( $T_J = 25\text{ °C}$ unless otherwise specified)

Symbol	Characteristic	Conditions	Value			Unit
			Min.	Typ.	Max.	
$BV_{CES}$	Collector-Emitter Breakdown Voltage	$I_C = 250\ \mu\text{A}, V_{GE} = 0\text{ V}$	650	–	–	V
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C = 250\ \mu\text{A}, V_{CE} = V_{GE}$	3.7	–	5.8	V
$I_{GES}$	Gate-Emitter Leakage Current	$V_{CE} = 0\text{ V}, V_{GE} = \pm 20\text{ V}$	–	–	$\pm 200$	nA
$I_{CES}$	Zero Gate Voltage Collector Current	$V_{CE} = V_{CES}, V_{GE} = 0\text{ V}$	–	–	5	$\mu\text{A}$
		$V_{CE} = V_{CES}, V_{GE} = 0\text{ V}, T_J = 150\text{ °C}$	–	–	750	$\mu\text{A}$
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage <sup>1</sup>	$I_C = 75\text{ A}, V_{GE} = 15\text{ V}$	–	1.22	1.45	V
		$I_C = 75\text{ A}, V_{GE} = 15\text{ V}, T_J = 150\text{ °C}$	–	1.30	–	V

**Note 1:** Pulse test,  $t \leq 300\ \mu\text{s}$ , duty cycle,  $d \leq 2\%$

## Electrical Characteristics – Dynamic ( $T_J = 25\text{ °C}$ unless otherwise specified)

Symbol	Characteristic	Conditions	Value			Unit	
			Min.	Typ.	Max.		
$g_{fs}$	Transconductance <sup>1</sup>	$I_C = 60\text{ A}, V_{CE} = 10\text{ V}$	40	80	–	S	
$C_{ies}$	Input Capacitance	$V_{GE} = 25\text{ V}, V_{CE} = 0\text{ V}, f = 1\text{ MHz}$	–	5060	–	pF	
$C_{oes}$	Output Capacitance		–	255	–		
$C_{res}$	Reverse Transfer Capacitance		–	190	–		
$Q_{g(on)}$	Total Gate Charge	$V_{GE} = 15\text{ V}, V_{CE} = 0.5 \times V_{CES},$ $I_C = 90\text{ A}$	–	314	–	nC	
$Q_{ge}$	Gate-Emitter Charge		–	41	–		
$Q_{gc}$	Gate-Collector Charge		–	157	–		
$t_{d(on)}$	Turn-on Delay Time <sup>2</sup>	Inductive Load, $V_{GE} = 15\text{ V}, V_{CE} = 400\text{ V},$ $I_C = 60\text{ A}, R_{G(ext)} = 3\ \Omega$	$T_J = 25\text{ °C}$	–	46	–	ns
			$T_J = 150\text{ °C}$	–	33	–	
$t_{ri}$	Turn-on Rise Time <sup>2</sup>		$T_J = 25\text{ °C}$	–	45	–	ns
			$T_J = 150\text{ °C}$	–	48	–	
$E_{on}$	Turn-on Energy <sup>2</sup>		$T_J = 25\text{ °C}$	–	2.46	–	mJ
			$T_J = 150\text{ °C}$	–	3.60	–	
$t_{d(off)}$	Turn-off Delay Time <sup>2</sup>		$T_J = 25\text{ °C}$	–	390	–	ns
			$T_J = 150\text{ °C}$	–	380	–	
$t_{fi}$	Turn-off Fall Time <sup>2</sup>		$T_J = 25\text{ °C}$	–	200	–	ns
			$T_J = 150\text{ °C}$	–	310	–	
$E_{off}$	Turn-off Energy <sup>2</sup>	$T_J = 25\text{ °C}$	–	3.55	–	mJ	
		$T_J = 150\text{ °C}$	–	5.20	–		

**Note 1:** Pulse test,  $t \leq 300\ \mu\text{s}$ , duty cycle,  $d \leq 2\%$

**Note 2:** Switching times and energy losses may increase for higher  $V_{CE(clamp)}$ ,  $T_J$ , or  $R_G$ .

Characteristic Curves

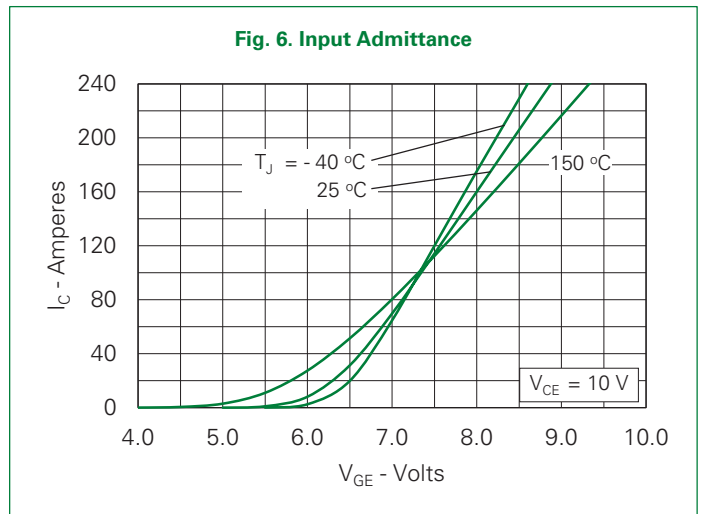
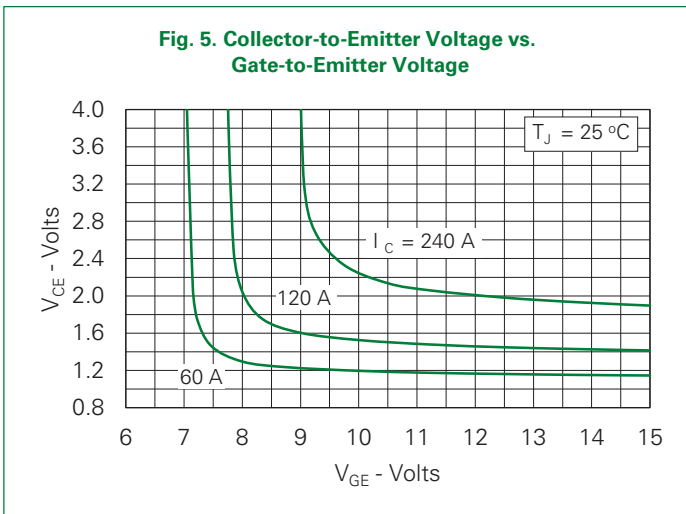
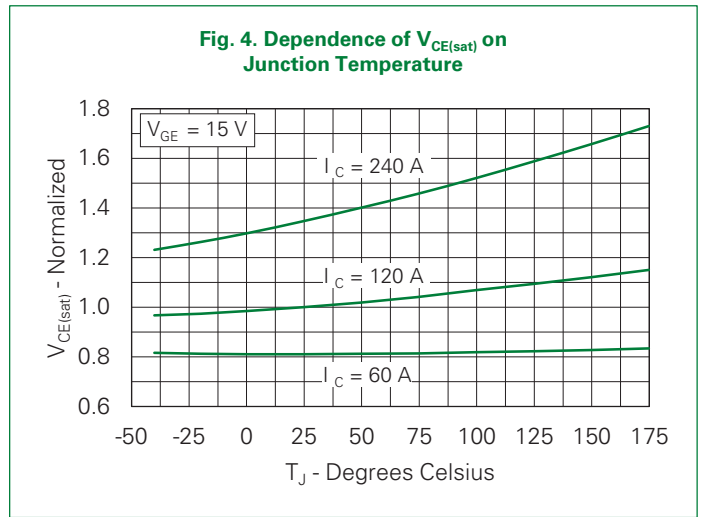
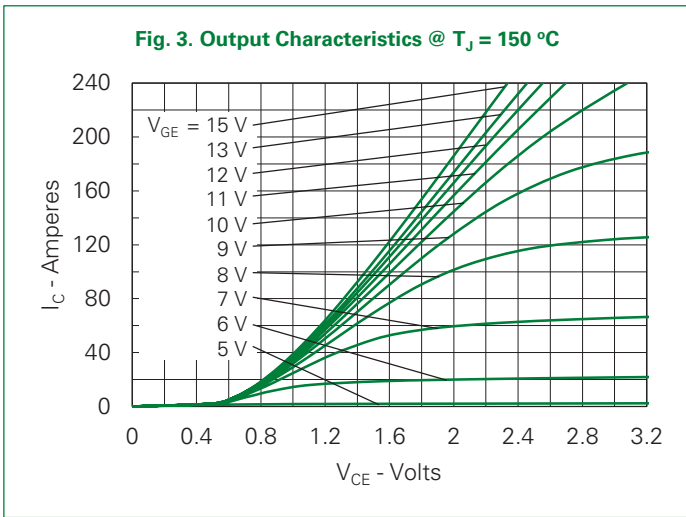
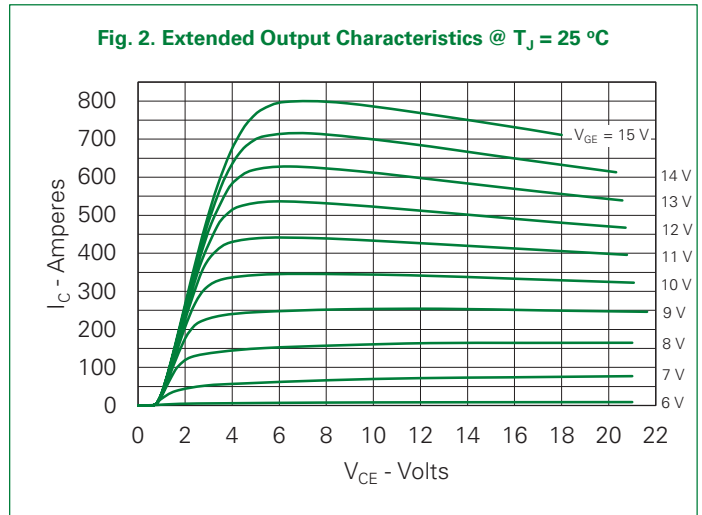
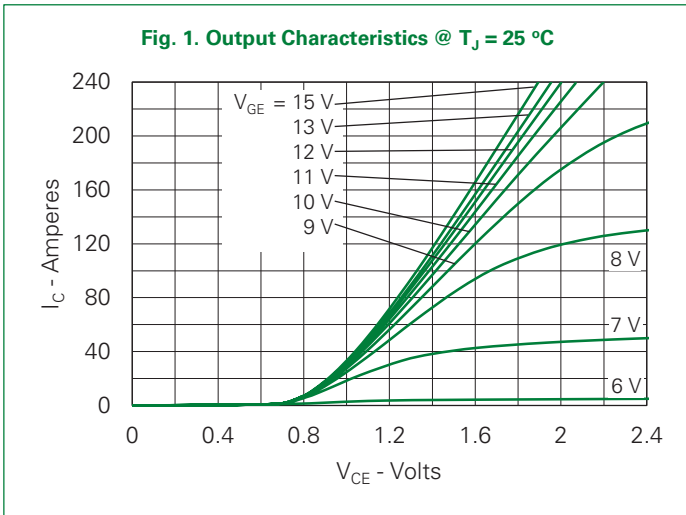


Fig. 7. Transconductance

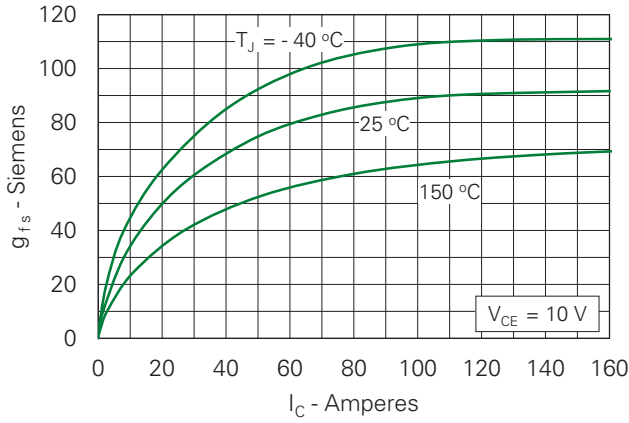


Fig. 8. Gate Charge

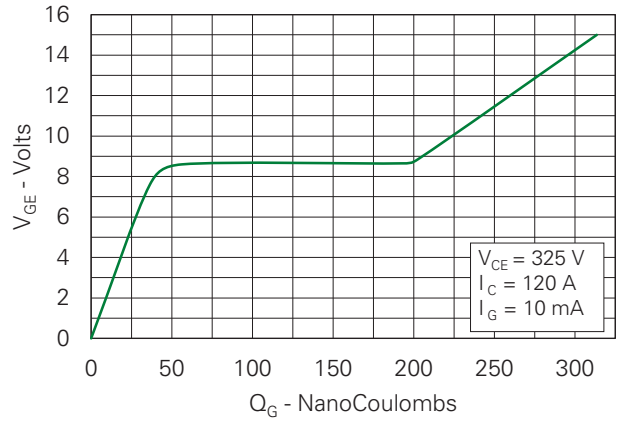


Fig. 9. Capacitance

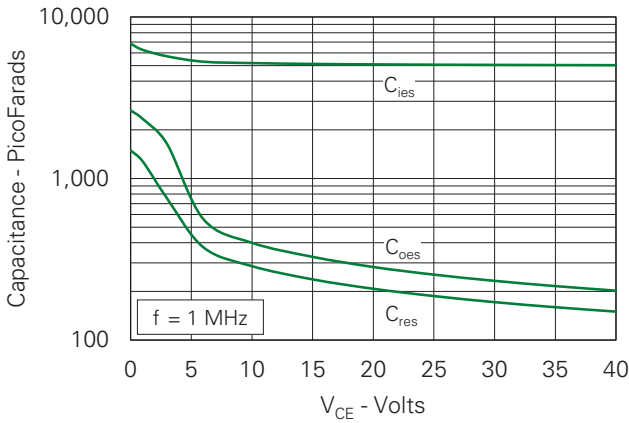


Fig. 10. Reverse-Bias Safe Operating Area

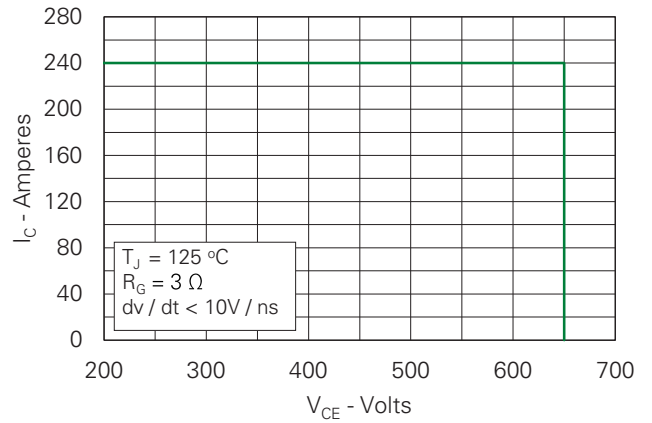


Fig. 11. Maximum Transient Thermal Impedance

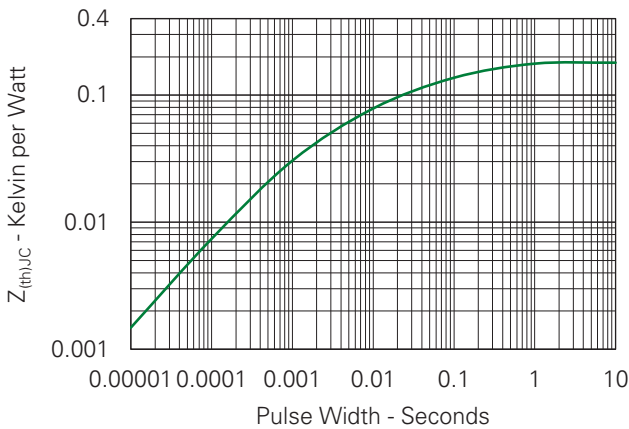
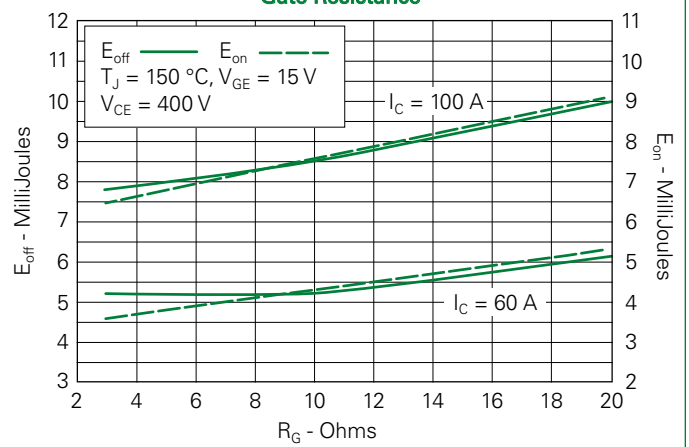
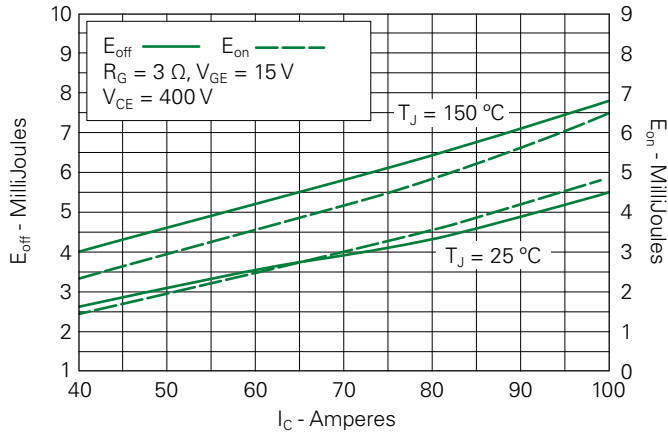


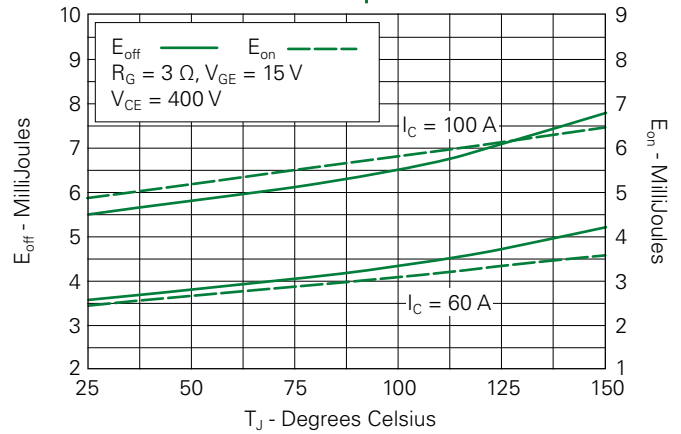
Fig. 12. Inductive Switching Energy Loss vs. Gate Resistance



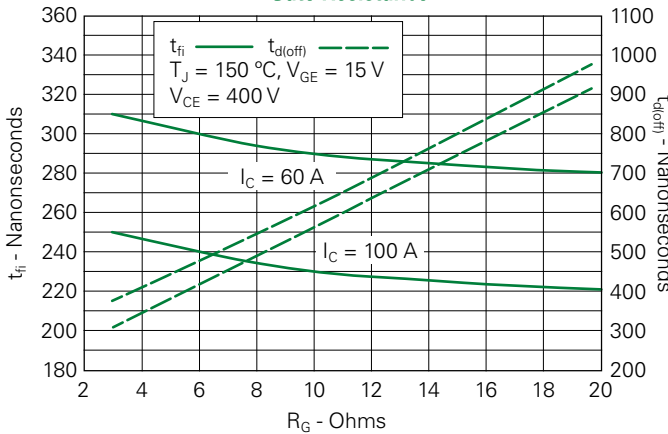
**Fig. 13. Inductive Switching Energy Loss vs. Collector Current**



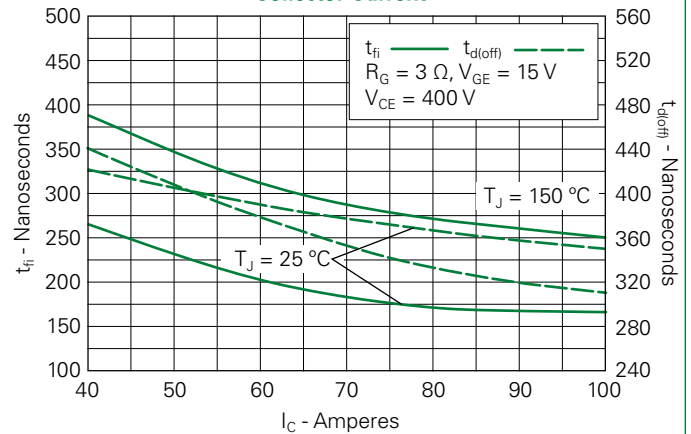
**Fig. 14. Inductive Switching Energy Loss vs. Junction Temperature**



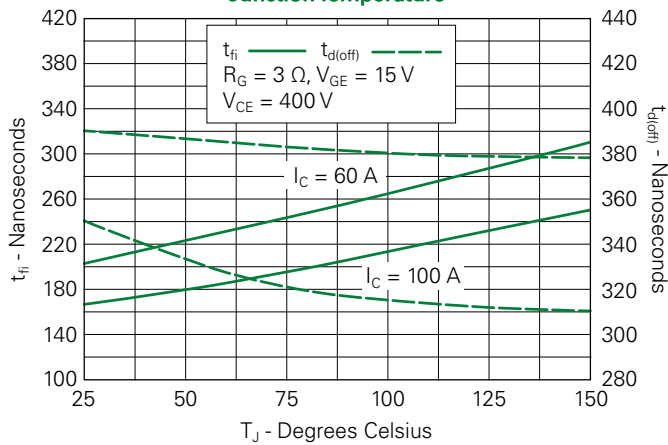
**Fig. 15. Inductive Turn-off Switching Times vs. Gate Resistance**



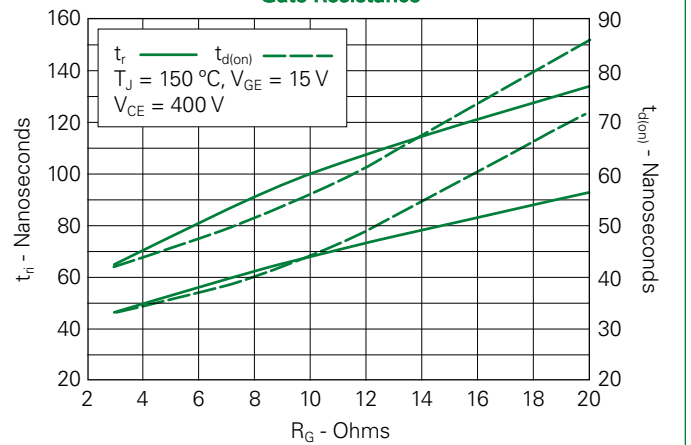
**Fig. 16. Inductive Turn-off Switching Times vs. Collector Current**



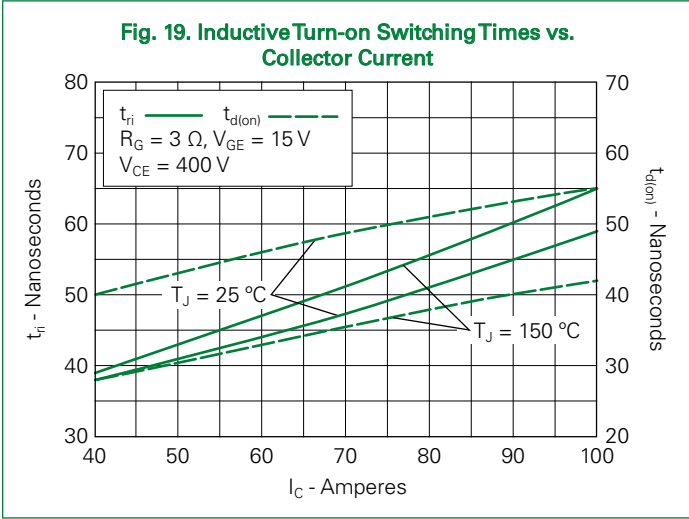
**Fig. 17. Inductive Turn-off Switching Times vs. Junction Temperature**



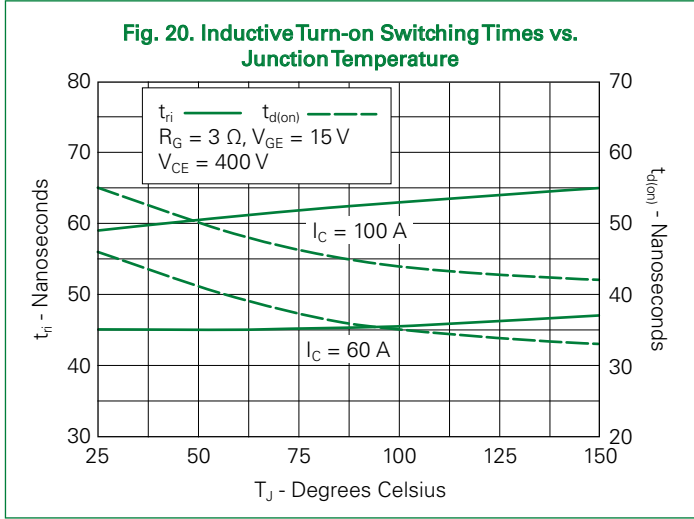
**Fig. 18. Inductive Turn-on Switching Times vs. Gate Resistance**



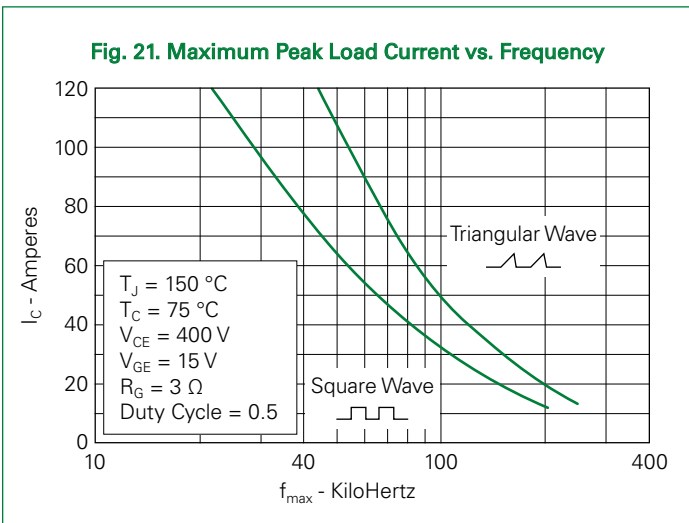
**Fig. 19. Inductive Turn-on Switching Times vs. Collector Current**



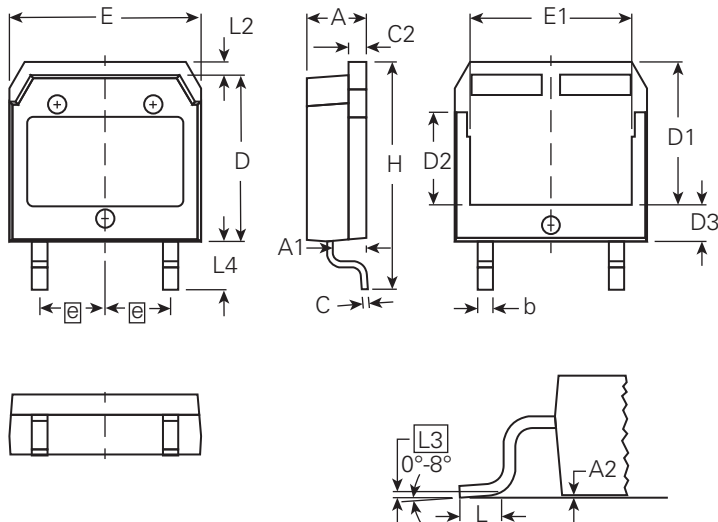
**Fig. 20. Inductive Turn-on Switching Times vs. Junction Temperature**



**Fig. 21. Maximum Peak Load Current vs. Frequency**



## Part Outline Drawing (TO-268HV)



Symbol	Inches			Millimeters		
	Min.	Typical	Max.	Min.	Typical	Max
A	0.193	–	0.201	4.90	–	5.10
A1	0.106	–	0.114	2.70	–	2.90
A2	0.001	–	0.010	0.02	–	0.25
b	0.045	–	0.057	1.15	–	1.45
C	0.016	–	0.026	0.40	–	0.65
C2	0.057	–	0.063	1.45	–	1.60
D	0.543	–	0.551	13.80	–	14.00
D1	0.465	–	0.476	11.80	–	12.10
D2	0.295	–	0.307	7.50	–	7.80
D3	0.114	–	0.126	2.90	–	3.20
E	0.624	–	0.632	15.85	–	16.05
E1	0.524	–	0.535	13.30	–	13.60
e	0.215 BSC			5.45 BSC		
e2	0.374	–	0.386	9.50	–	9.80
H	0.736	–	0.752	18.70	–	19.10
L	0.067	–	0.079	1.70	–	2.00
L2	0.039	–	0.045	1.00	–	1.15
L3	0.010 BSC			0.25 BSC		
L4	0.150	–	0.161	3.80	–	4.10

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Part of:

